MOTOROLA
SEMICONDUCTOR TECHNICAL DATA

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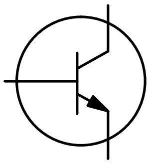
MJE18206
MJF18206

Designer's™ Data Sheet

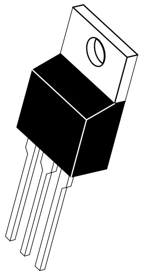
SWITCHMODE™ NPN Bipolar Power Transistor for Electronic Light Ballast and Switching Power Supply Applications

POWER TRANSISTORS
8 AMPERES
1200 VOLTS
40 and 100 WATTS

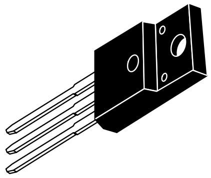


The MJE/MJF18206 have an application specific state–of–the–art die dedicated to the electronic ballast ("light ballast") and power supply applications.

- Improved Global Efficiency Due to Low Base Drive Requirements:
  - — High and Flat DC Current Gain h_{FE}
  - — Fast Switching
  - — No Coil Required in Base Circuit for fast Turn–Off (No Current Tail)
- Full Characterization at 125°C
- Motorola "6 SIGMA" Philosophy Provides Tight and Reproducible Parametric Distributions
- Two Package Choices: Standard TO–220 or Isolated TO–220



CASE 221A–06
TO–220AB



CASE 221D–02
TO–220 FULLPACK

MAXIMUM RATINGS

Rating	Symbol	MJE18206	MJF18206	Unit
Collector–Emitter Voltage	V_{CEO}	600		Vdc
Collector–Base Voltage	V_{CBO}	1200		Vdc
Collector–Emitter Voltage	V_{CES}	1200		Vdc
Emitter–Base Voltage	V_{EBO}	10		Vdc
Collector Current — Continuous — Peak (1)	I_C I_{CM}	8 16		Adc
Base Current — Continuous — Peak (1)	I_B I_{BM}	5 9		Adc
RMS Isolation Voltage (2) Per Figure 22 (for 1 sec, R.H. ≤ 30%) Per Figure 23 T_C = 25°C Per Figure 24	V_{ISOL1} V_{ISOL2} V_{ISOL3}		4500 3500 1500	Volts
*Total Device Dissipation @ T_C = 25°C *Derate above 25°C	P_D	100 0.8	40 0.32	Watt W/°C
Operating and Storage Temperature	T_J, T_{stg}	–65 to 150		°C

THERMAL CHARACTERISTICS

Rating	Symbol	MJE18206	MJF18206	Unit
Thermal Resistance — Junction to Case — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$	1.25 62.5	3.125 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8″ from Case for 5 Seconds	T_L	260		°C

(1) Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.
(2) Proper strike and creepage distance must be provided.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Collector–Emitter Sustaining Voltage (I_C = 100 mA, L = 25 mH)		$V_{CEO(sus)}$	550	630		Vdc
(I_C = 200 mA, L = 25 mH, R = 200 Ω)		$V_{CER(sus)}$	600	700		
Collector–Base Breakdown Voltage (I_{CBO} = 1 mA, I_E = 0)		V_{CBO}	1200	1320		Vdc
Emitter–Base Breakdown Voltage (I_{EBO} = 1 mA, I_C = 0)		V_{EBO}	10	12.9		Vdc
Collector Cutoff Current (V_{CE} = 550 V, I_B = 0)	@ T_C = 25°C	I_{CEO}			200	µAdc
(V_{CE} = 550 V, I_B = 0)	@ T_C = 125°C				2000	
Collector Cutoff Current (V_{CE} = Rated V_{CES}, V_{BE} = 0)	@ T_C = 25°C	I_{CES}			100	µAdc
	@ T_C = 125°C				1000	
(V_{CE} = 1000 V, V_{BE} = 0)	@ T_C = 125°C				100	
Collector Cutoff Current (V_{CB} = 1200 V, I_E = 0)		I_{CBO}			100	µAdc
Emitter–Cutoff Current (V_{EB} = 9 Vdc, I_C = 0)		I_{EBO}			100	µAdc
ON CHARACTERISTICS						
Base–Emitter Saturation Voltage (I_C = 1.3 Adc, I_B = 0.13 Adc)	@ T_C = 25°C	$V_{BE(sat)}$		0.77	1	Vdc
	@ T_C = 125°C			0.67	0.9	
(I_C = 2 Adc, I_B = 0.4 Adc)	@ T_C = 25°C			0.85	1.1	
	@ T_C = 125°C			0.75	1	
(I_C = 3 Adc, I_B = 0.6 Adc)	@ T_C = 25°C			0.91	1.1	
	@ T_C = 125°C			0.8	1	
Collector–Emitter Saturation Voltage (I_C = 1.3 Adc, I_B = 0.13 Adc)	@ T_C = 25°C	$V_{CE(sat)}$		0.3	0.75	Vdc
	@ T_C = 125°C			0.4	1	
(I_C = 3 Adc, I_B = 0.6 Adc)	@ T_C = 25°C			0.4	0.75	
	@ T_C = 125°C			0.8	1.25	
DC Current Gain (I_C = 0.5 Adc, V_{CE} = 5 Vdc)	@ T_C = 25°C	h_{FE}	18	25		—
	@ T_C = 125°C			25		
(I_C = 1 Adc, V_{CE} = 5 Vdc)	@ T_C = 25°C		18		45	
	@ T_C = 125°C			20		
(I_C = 3 Adc, V_{CE} = 1 Vdc)	@ T_C = 25°C		5	8		—
	@ T_C = 125°C		4	6		
(I_C = 10 mAdc, V_{CE} = 5 Vdc)	@ T_C = 25°C		11		50	—
	@ T_C = 125°C			33		
DYNAMIC CHARACTERISTICS						
Current Gain Bandwidth (I_C = 0.5 Adc, V_{CE} = 10 Vdc, f = 1 MHz)		f_T		13		MHz
Output Capacitance (V_{CB} = 10 Vdc, I_E = 0, f = 1 MHz)		C_{ob}			200	pF
Input Capacitance (V_{EB} = 8 Vdc)		C_{ib}			2000	pF

DYNAMIC SATURATION VOLTAGE

Dynamic Saturation Voltage: Determined 1 µs and 3 µs respectively after rising I_{B1} reaches 90% of final I_{B1}	I_C = 1.3 Adc I_{B1} = 130 mAdc V_{CC} = 300 V	@ 1 µs	@ T_C = 25°C	$V_{CE(dsat)}$		7.5		V
		@ 3 µs	@ T_C = 25°C			4.5		
	I_C = 3 Adc I_{B1} = 0.6 Adc V_{CC} = 300 V	@ 1 µs	@ T_C = 25°C			14.5		
		@ 3 µs	@ T_C = 25°C			6		

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic			Symbol	Min	Typ	Max	Unit
SWITCHING CHARACTERISTICS: Resistive Load (D.C. ≤ 10%, Pulse Width = 40 µs)							
Turn–on Time	I_C = 3 Adc, I_{B1} = 0.6 Adc I_{B2} = 1.5 Adc V_{CC} = 300 Vdc	@ T_C = 25°C	t_{on}		200	350	ns
Turn–off Time		@ T_C = 25°C @ T_C = 125°C	t_{off}		2 2.5	2.5	µs
Turn–on Time	I_C = 3 Adc, I_{B1} = 0.6 Adc I_{B2} = 0.6 Adc V_{CC} = 300 Vdc	@ T_C = 25°C	t_{on}		190	250	ns
Turn–off Time		@ T_C = 25°C @ T_C = 125°C	t_{off}		3.7 4.5	4.5	µs
Turn–on Time	I_C = 1 Adc, I_{B1} = 70 mAdc I_{B2} = 1 Adc V_{CC} = 125 Vdc PW = 70 µs	@ T_C = 25°C	t_d		125	300	ns
			t_r		400	750	ns
Turn–off Time		@ T_C = 25°C	t_s		600	1.2	µs
			t_f		450	700	ns
Turn–on Time	I_C = 1 Adc, I_{B1} = 100 mAdc I_{B2} = 500 mAdc V_{CC} = 300 Vdc	@ T_C = 25°C @ T_C = 125°C	t_{on}		250 225	350	ns
Turn–off Time		@ T_C = 25°C @ T_C = 125°C	t_{off}		2 2.5	2.75	µs
SWITCHING CHARACTERISTICS: Inductive Load (V_{clamp} = 300 V, V_{CC} = 15 V, L = 200 µH)							
Fall Time	I_C = 1.3 Adc I_{B1} = 0.13 Adc I_{B2} = 0.65 Adc	@ T_C = 25°C @ T_C = 125°C	t_f		150 225	200	ns
Storage Time		@ T_C = 25°C @ T_C = 125°C	t_s		1.6 1.9	2	µs
Crossover Time		@ T_C = 25°C @ T_C = 125°C	t_c		260 300	350	ns
Fall Time	I_C = 3 Adc I_{B1} = 0.6 Adc I_{B2} = 1.5 Adc	@ T_C = 25°C @ T_C = 125°C	t_f		300 400	450	ns
Storage Time		@ T_C = 25°C @ T_C = 125°C	t_s		2.25 2.5	2.75	µs
Crossover Time		@ T_C = 25°C @ T_C = 125°C	t_c		500 700	800	ns
Fall Time	I_C = 3 Adc I_{B1} = 0.6 Adc I_{B2} = 0.6 Adc	@ T_C = 25°C @ T_C = 125°C	t_f		350 500	500	ns
Storage Time		@ T_C = 25°C @ T_C = 125°C	t_s		4.25 5.1	5	µs
Crossover Time		@ T_C = 25°C @ T_C = 125°C	t_c		600 1100	800	ns

TYPICAL STATIC CHARACTERISTICS

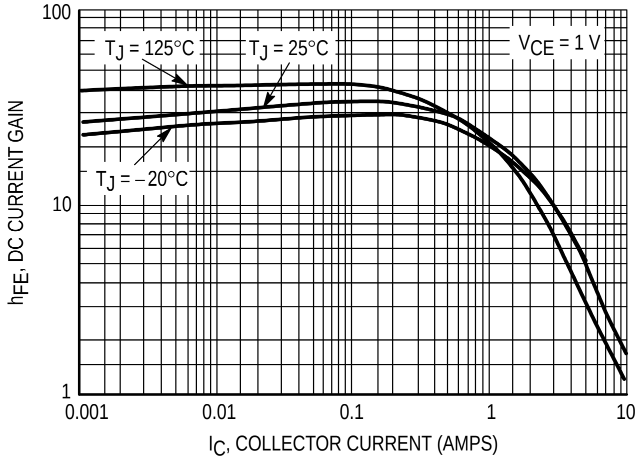


Figure 1. DC Current Gain @ 1 Volt

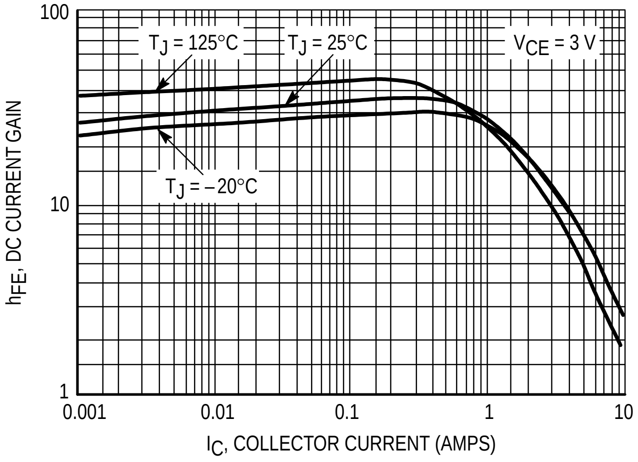


Figure 2. DC Current Gain @ 3 Volts

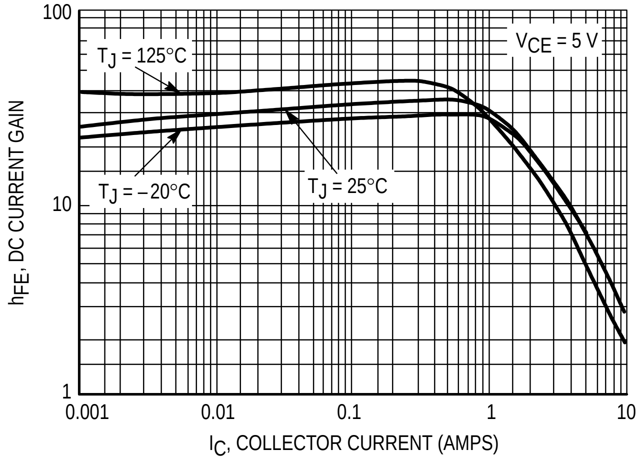


Figure 3. DC Current Gain @ 5 Volts

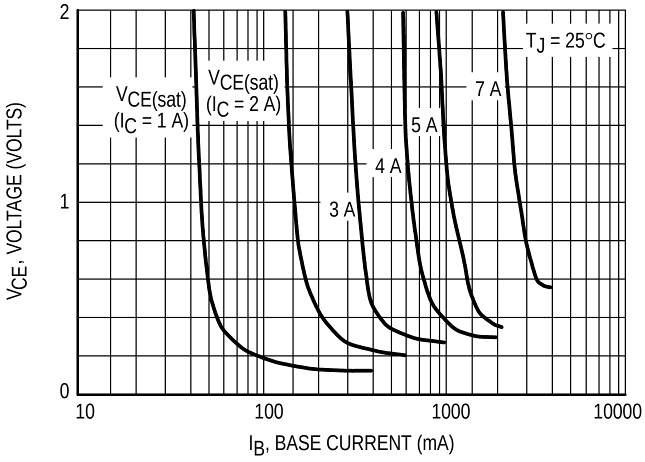


Figure 4. Collector Saturation Region

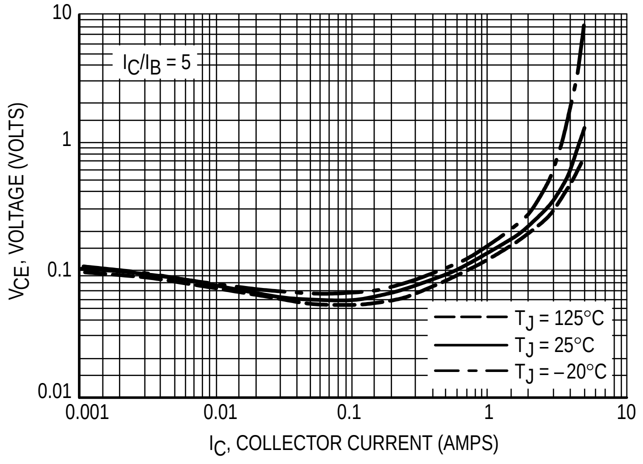


Figure 5A. Collector–Emitter Saturation Voltage

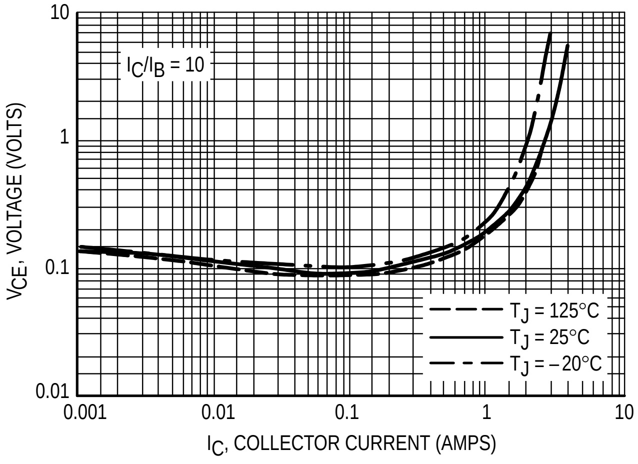


Figure 5B. Collector–Emitter Saturation Voltage

TYPICAL STATIC CHARACTERISTICS

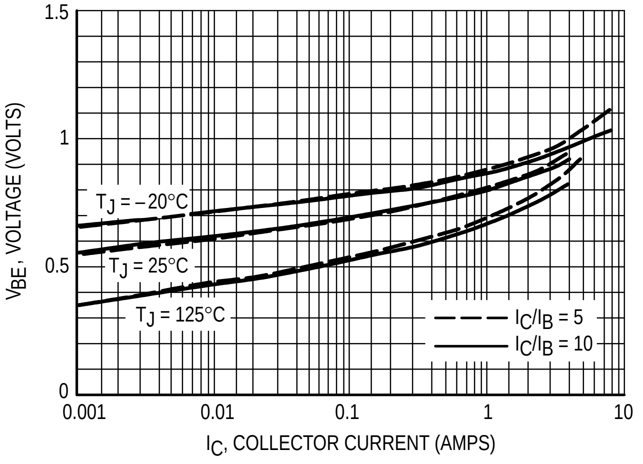


Figure 6. Base–Emitter Saturation Region

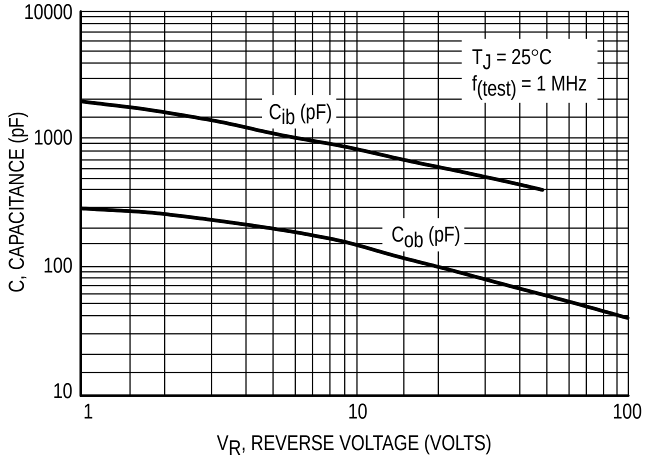


Figure 7. Capacitance

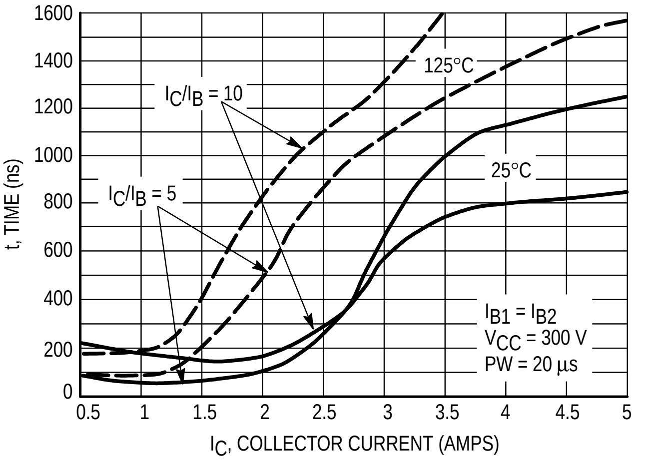


Figure 8. Resistive Switching, t_{on}

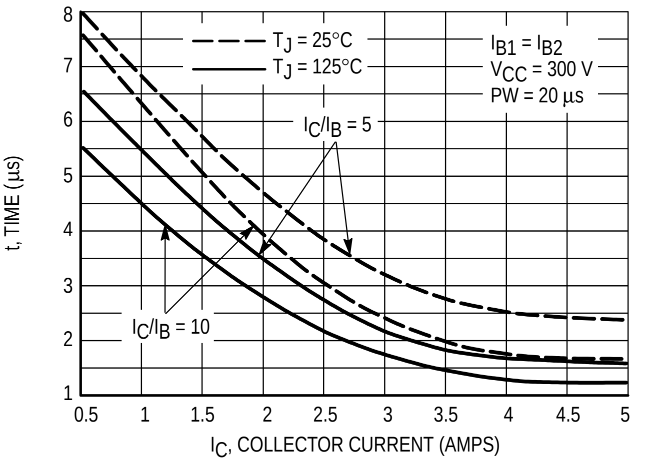


Figure 9. Resistive Switching, t_{off}

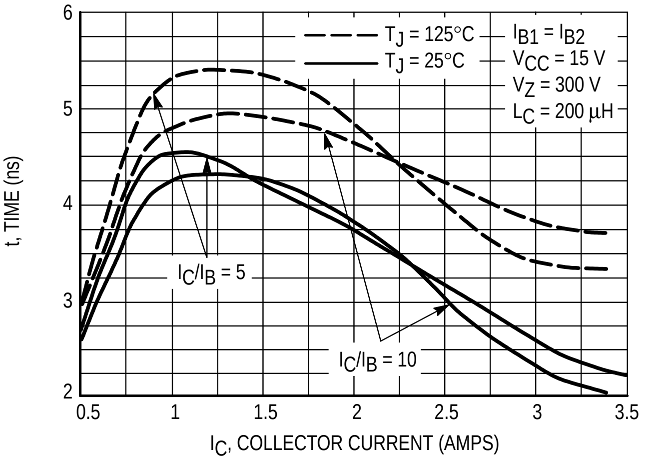


Figure 10. Inductive Storage Time, t_{si}

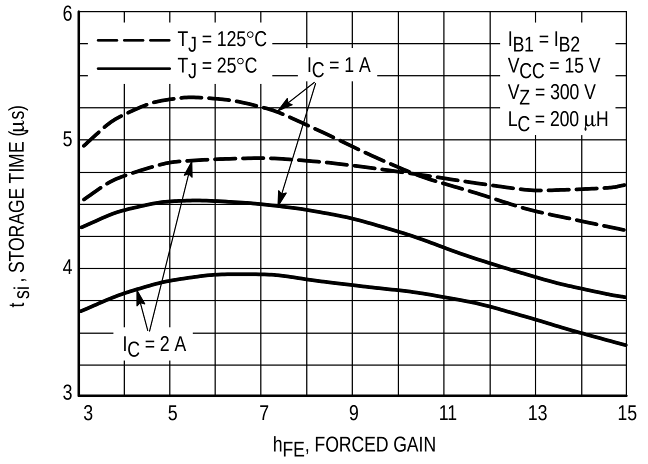


Figure 11. Inductive Storage Time

TYPICAL STATIC CHARACTERISTICS

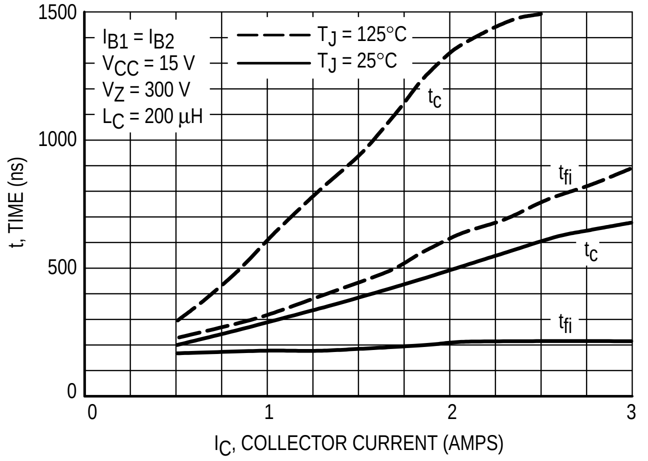


Figure 12. Inductive Switching, t_c & t_{fi} @ I_C/I_B = 5

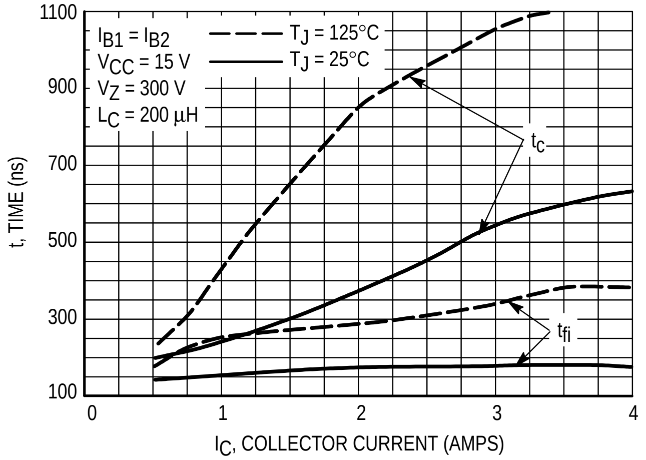


Figure 13. Inductive Switching, t_c & t_{fi} @ I_C/I_B = 10

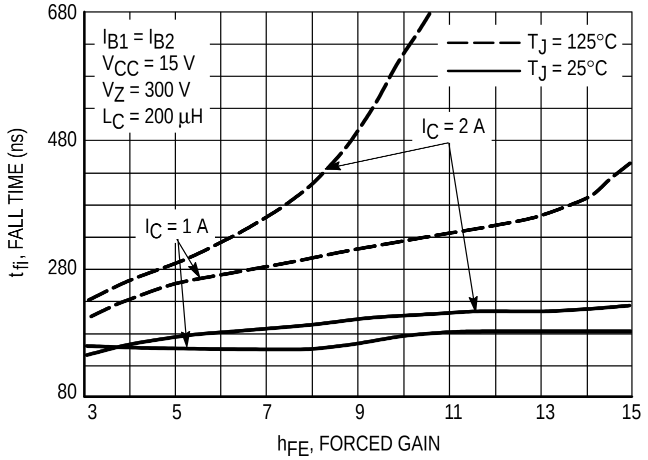


Figure 14. Inductive Fall Time

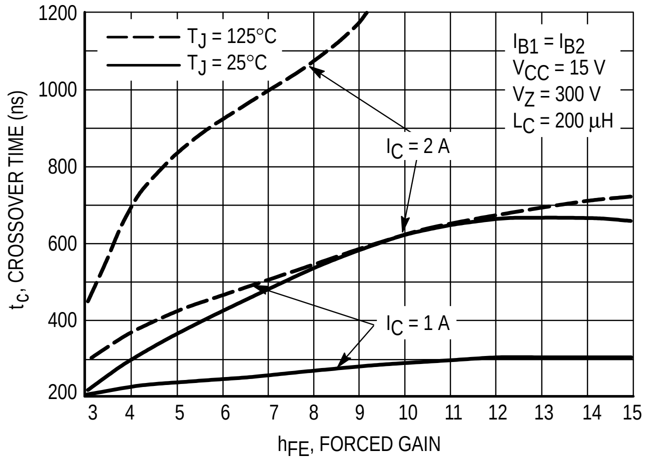


Figure 15. Inductive Crossover Time

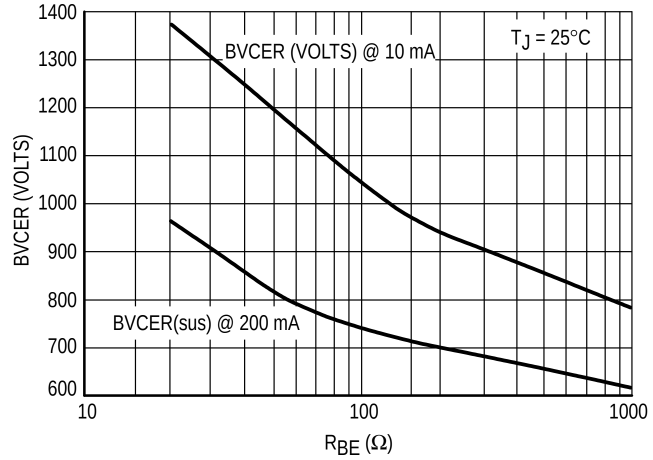


Figure 16. BVCER = f (R_{BE})

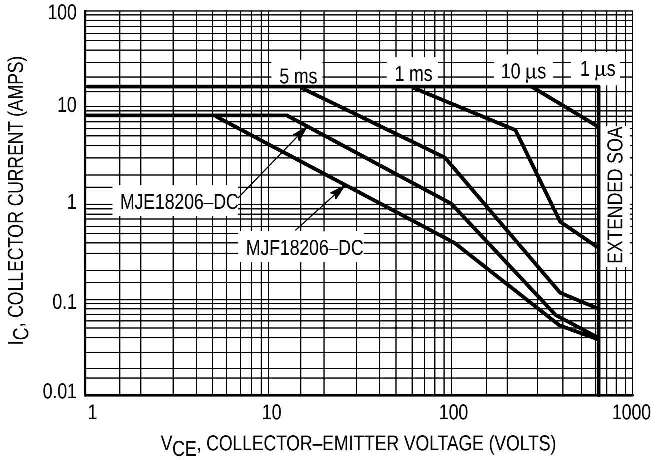


Figure 17. Forward Bias Safe Operating Area

TYPICAL STATIC CHARACTERISTICS

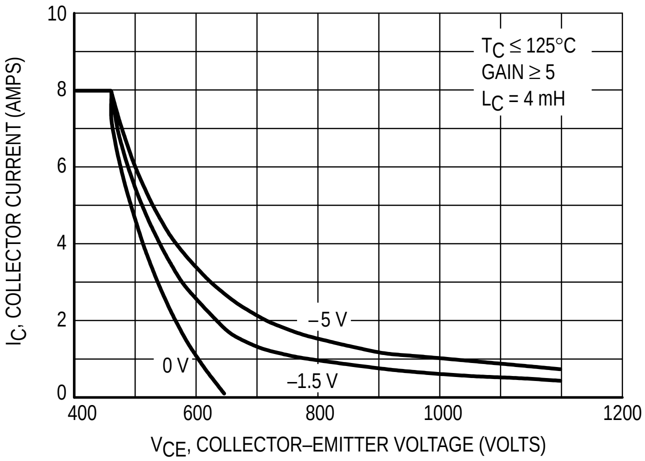


Figure 18. Reverse Bias Switching Safe Operating Area

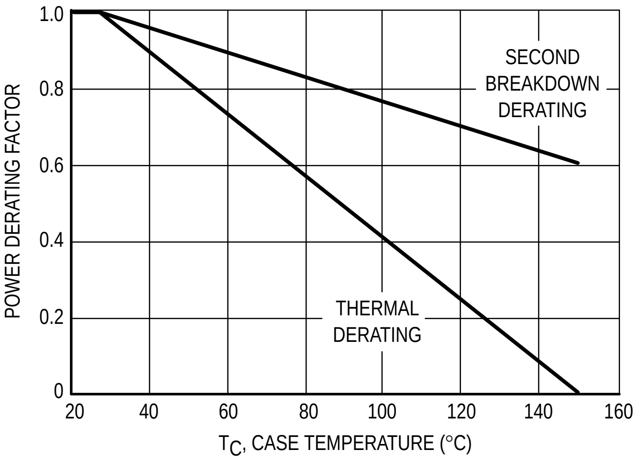


Figure 19. Forward Bias Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C–V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 17 is based on T_C = 25°C; T_J(pk) is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when T_C > 25°C. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 17 may be found at any case temperature by using the appropriate curve on Figure 19.

T_J(pk) may be calculated from the data in Figures 22 and 23. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn–off with the base–to–emitter junction reverse biased. The safe level is specified as a reverse–biased safe operating area (Figure 18). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

TYPICAL SWITCHING CHARACTERISTICS
(I_{B1} = I_{B2} FOR ALL CURVES)

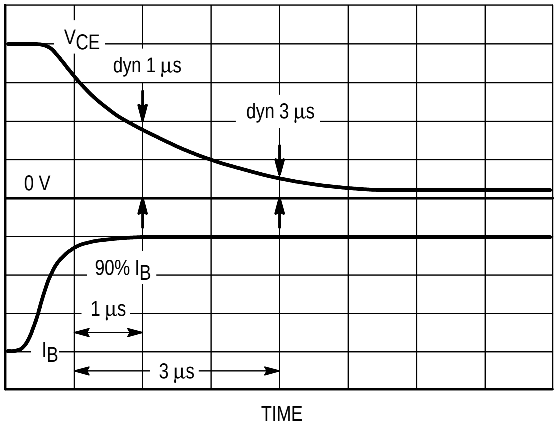


Figure 20. Dynamic Saturation Voltage Measurements

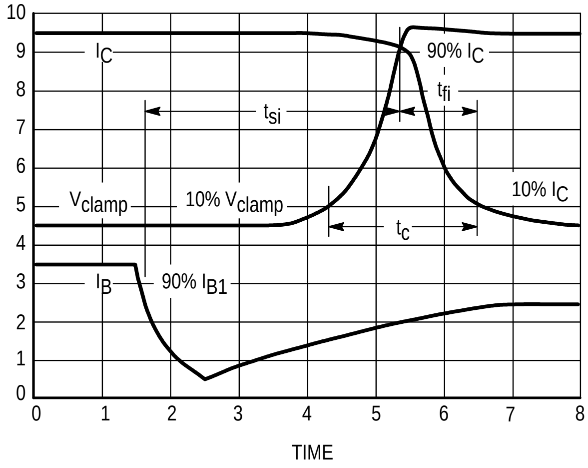
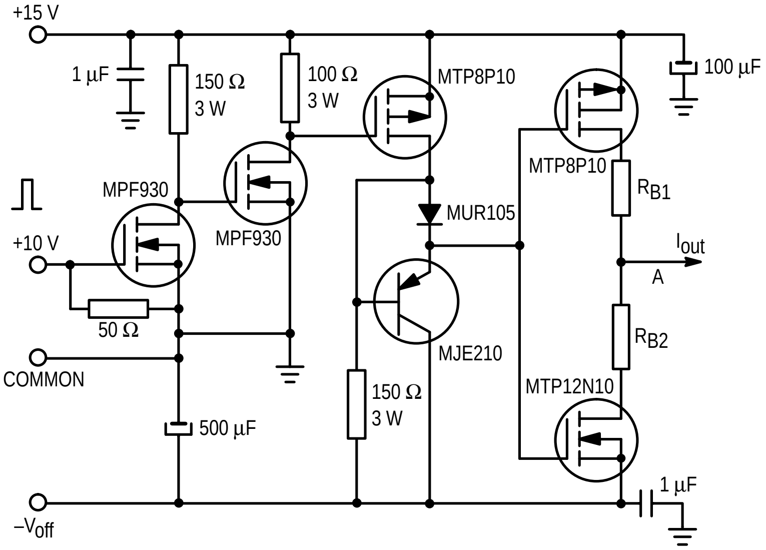
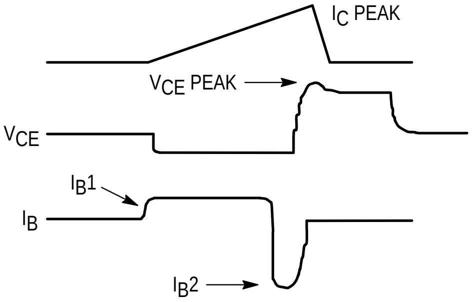


Figure 21. Inductive Switching Measurements

TYPICAL SWITCHING CHARACTERISTICS
($I_{B1} = I_{B2}$ FOR ALL CURVES)

Table 1. Inductive Load Switching Drive Circuit





$V_{(BR)CEO(sus)}$	Inductive Switching	RBSOA
L = 10 mH	L = 200 µH	L = 500 µH
$R_{B2} = \infty$	R_{B2} = 0	R_{B2} = 0
V_{CC} = 20 Volts	V_{CC} = 15 Volts	V_{CC} = 15 Volts
$I_{C(pk)}$ = 100 mA	R_{B1} selected for desired I_{B1}	R_{B1} selected for desired I_{B1}

TYPICAL THERMAL RESPONSE
($I_{B1} = I_{B2}$ FOR ALL CURVES)

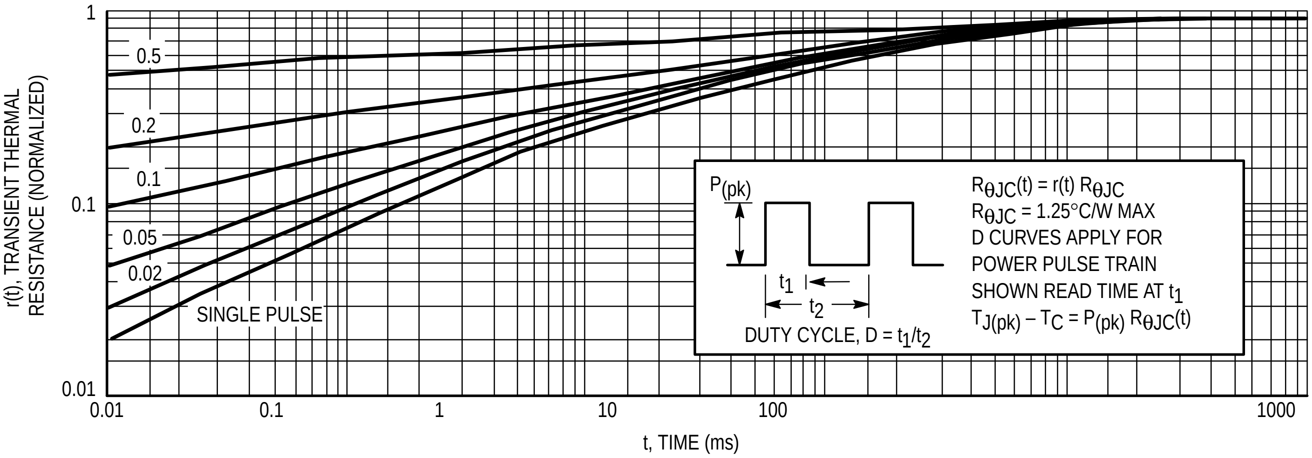


Figure 22. Typical Thermal Response ($Z_{\theta JC(t)}$) for MJE18206

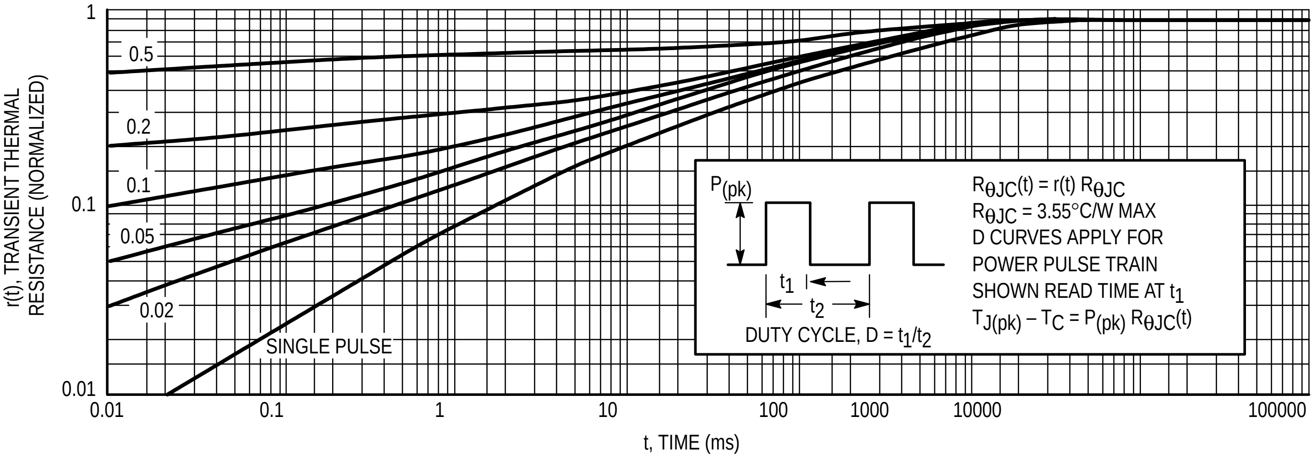


Figure 23. Typical Thermal Response ($Z_{\theta JC(t)}$) for MJF18206

TEST CONDITIONS FOR ISOLATION TESTS*

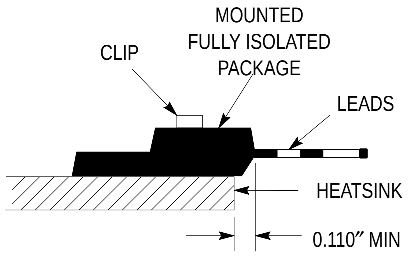


Figure 24. Clip Mounting Position for Isolation Test Number 1

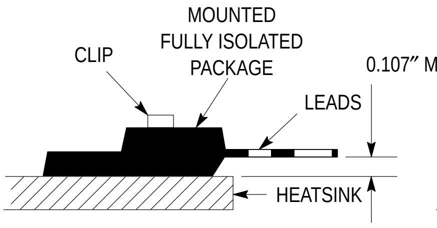


Figure 25. Clip Mounting Position for Isolation Test Number 2

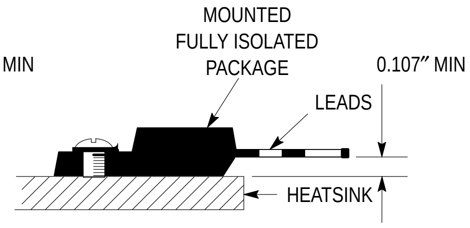


Figure 26. Screw Mounting Position for Isolation Test Number 3

* Measurement made between leads and heatsink with all leads shorted together

MOUNTING INFORMATION**

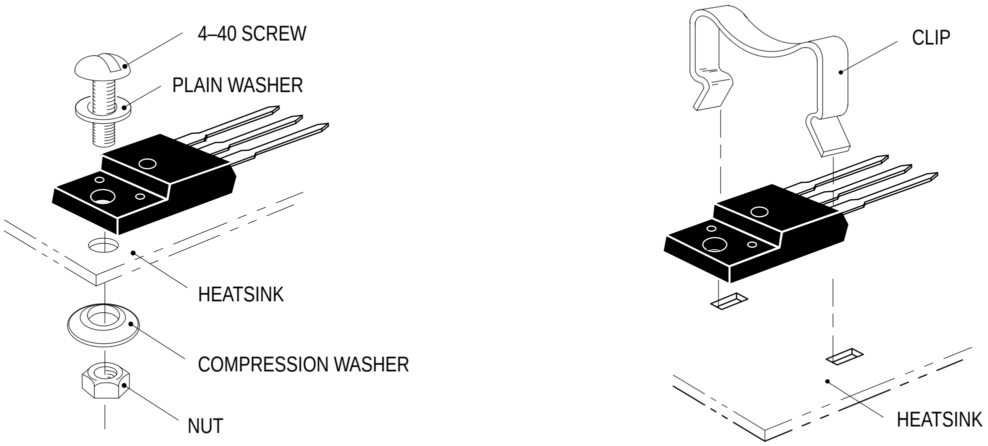


Figure 27a. Screw–Mounted

Figure 27b. Clip–Mounted

Figure 27. Typical Mounting Techniques for Isolated Package

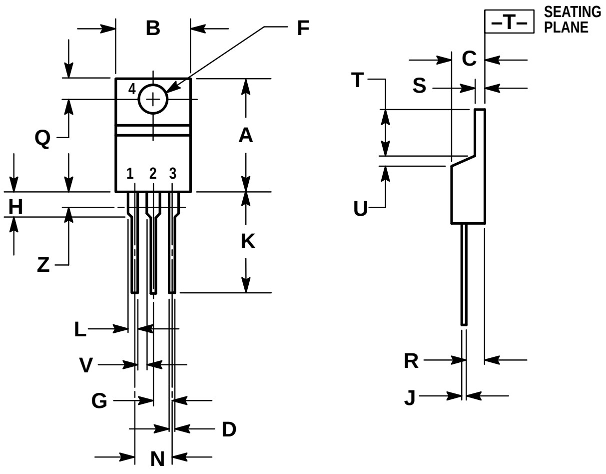
Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4–40 screw, without washers, and applying a torque in excess of 20 in · lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4–40 screws indicate that the screw slot fails between 15 to 20 in · lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, Motorola does not recommend exceeding 10 in · lbs of mounting torque under any mounting conditions.

** For more information about mounting power semiconductors see Application Note AN1040.

PACKAGE DIMENSIONS

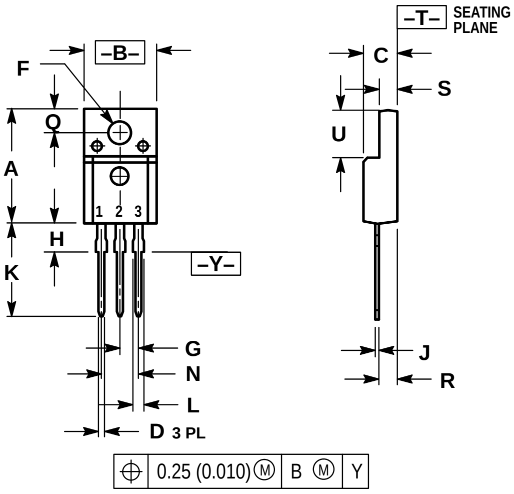


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	**MIN**	**MAX**	**MIN**	**MAX**
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	—	1.15	—
Z	—	0.080	—	2.04

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

CASE 221A–06
TO–220AB
ISSUE Y



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	**MIN**	**MAX**	**MIN**	**MAX**
A	0.621	0.629	15.78	15.97
B	0.394	0.402	10.01	10.21
C	0.181	0.189	4.60	4.80
D	0.026	0.034	0.67	0.86
F	0.121	0.129	3.08	3.27
G	0.100 BSC		2.54 BSC	
H	0.123	0.129	3.13	3.27
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
N	0.200 BSC		5.08 BSC	
Q	0.126	0.134	3.21	3.40
R	0.107	0.111	2.72	2.81
S	0.096	0.104	2.44	2.64
U	0.259	0.267	6.58	6.78

STYLE 1:
PIN 1. GATE
2. DRAIN
3. SOURCE

CASE 221D–02
(ISOLATED TO–220 TYPE)
UL RECOGNIZED: FILE #E69369
ISSUE D

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